

Features



- Dual data-rate 1.25Gbps/1.0625Gbps
- Up to 20km transmission on SMF
- 1310nm FP laser and PIN photodetector
- SFP MSA package with duplex LC connector
- Digital diagnostic monitor interface compliant with SFF-8472
- +3.3V single power supply
- Operating case temperature: -5 to +70°C
- RoHS compliant

Regulatory Compliance

Table 1 - Regulatory Compliance

Parameter	Standard	Compliance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883E Method 3015.7	Class 1
Electrostatic Discharge (ESD) to the Duplex LC Receptacle	IEC 61000-4-2	Compliant with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B	Compliant with standards
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN (IEC) 60825-1,2	Compliant with Class I laser product.
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883E Method 3015.7	Class 1

Absolute Maximum Ratings

Table 2 - Absolute Maximum Ratings

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Temperature	T _s	-40	-	+85	°C	
Supply Voltage	V _{CC}	-0.5	-	+3.6	V	
Operating Relative Humidity	RH	+5	-	+95	%	

Recommended Operating Conditions

Table 3 – Recommended Operating Conditions

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Operating Case Temperature	T_C	-5	-	+70	°C	
Power Supply Voltage	V_{CC}	3.13	3.3	3.47	V	
Power Supply Current	I_{CC}	-	-	300	mA	
Power Dissipation	P_D	-	-	1	W	
Data Rate		1.0625	1.25		Gbps	

Optical Characteristics

Table 4 – Optical Characteristics

Transmitter						
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Centre Wavelength	λ_C	1270	1310	1355	nm	
Average Output Power	P_{OUT}	-8		-3	dBm	1
$P_{out@TX}$ Disable Asserted	P_{OUT}			-45	dBm	1
Spectral Width (RMS)	$\Delta\lambda$		2	4	nm	
Extinction Ratio	EX	9			dB	
Rise/Fall Time (20%~80%)	t_r/t_f			0.26	ns	2
Total Jitter	1.25G	T_J		0.431	UI	3
	1.0625G			0.43		
Deterministic Jitter	1.25G	D_J		0.2	UI	3
	1.0625G			0.21		
Optical Eye Mask	IEEE 802.3ah and ANSI Fibre Channel compliant					4
Receiver						
Centre Wavelength	λ_C	1260		1570	nm	
Receiver Sensitivity	P_{IN}			-22	dBm	5
Receiver Overload	P_{IN}	-3			dBm	5
Return Loss		12			dB	
LOS Assert	LOS_A	-35			dBm	
LOS Deassert	LOS_D			-23	dBm	
LOS Hysteresis		0.5		4	dB	
Total Jitter	1.25G	T_J		0.749	UI	3
	1.0625G			0.61		
Deterministic Jitter	1.25G	D_J		0.462	UI	3
	1.0625G			0.36		

Notes:

1. The optical power is launched into SMF.
2. Unfiltered, measured with a PRBS 2^7-1 test pattern @1.25Gbps
3. Meet the specified maximum output jitter requirements if the specified maximum input jitter is present.
4. Measured with a PRBS 2^7-1 test pattern @1.25Gbps/1.0625Gbps.
5. Measured with a PRBS 2^7-1 test pattern @1.25Gbps, worst-case extinction ratio, BER $\leq 1 \times 10^{-12}$.

Electrical Characteristics

Table 5 – Electrical Characteristics

Transmitter						
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Data Input Swing Differential	V_{IN}	500		2400	mV	1
Input Differential Impedance	Z_{IN}	90	100	110	Ω	
Tx_DIS Disable	V_D	2.0		V_{CC}	V	
Tx_DIS Enable	V_{EN}	GND		GND+0.8	V	
TX_ Fault (Fault)		2.0		$V_{CC}+0.3$	V	
TX_ Fault (Normal)		0		0.8	V	
Receiver						
Data Output Swing Differential	V_{OUT}	370		2000	mV	1
Rx_LOS Fault	$V_{LOS-Fault}$	2.0		$V_{CC}+0.3$	V	
Rx_LOS Normal	$V_{LOS-Normal}$	GND		GND+0.8	V	

Notes:

1. Internally AC coupled

Recommended Host Board Power Supply Circuit

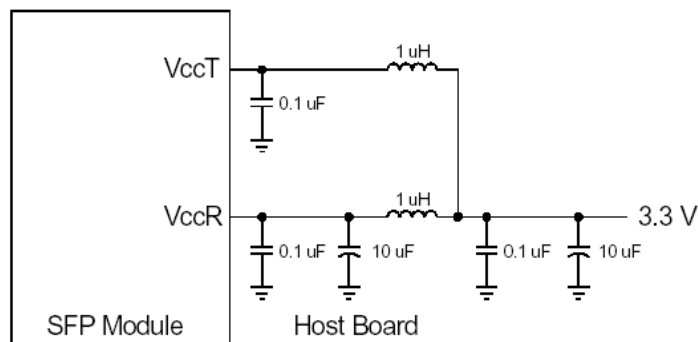


Figure 1, Recommended Host Board Power Supply Circuit

Recommended Interface Circuit

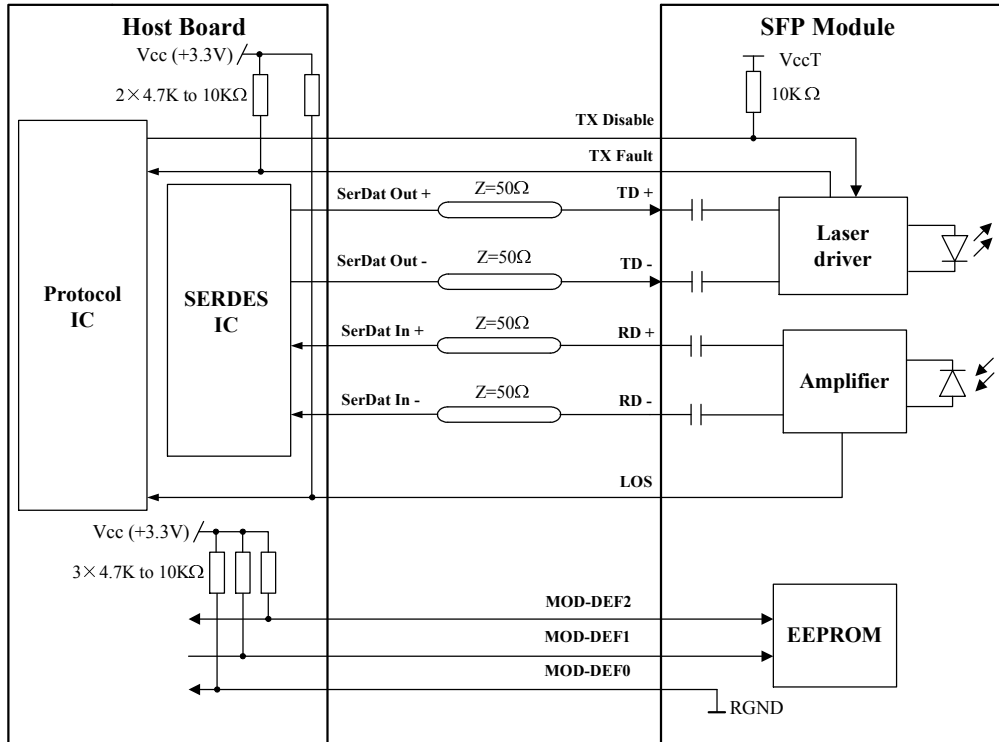


Figure 2, Recommended Interface Circuit

Pin Definitions

Figure 3 below shows the pin numbering of SFP electrical interface. The pin functions are described in Table 6 with some accompanying notes.

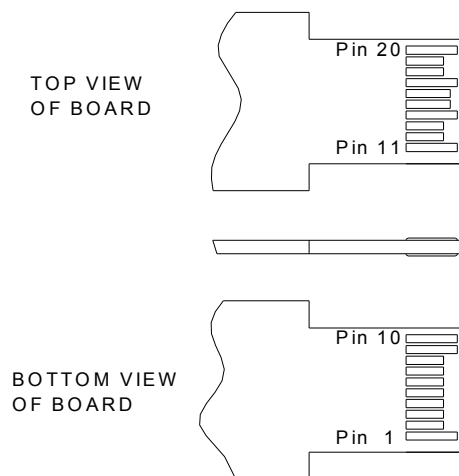


Figure 3, Pin View

Table 6 - Pin Function Definitions

Pin No.	Name	Function	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	TX Fault	Transmitter Fault Indication	3	Note 1
3	TX Disable	Transmitter Disable	3	Note 2
4	MOD-DEF2	Module Definition 2	3	Note 3
5	MOD-DEF1	Module Definition 1	3	Note 3
6	MOD-DEF0	Module Definition 0	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	VeeR	Receiver Ground	1	
10	VeeR	Receiver Ground	1	
11	VeeR	Receiver Ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	VeeR	Receiver Ground	1	
15	VccR	Receiver Power	2	
16	VccT	Transmitter Power	2	
17	VeeT	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	VeeT	Transmitter Ground	1	

Notes:

- TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a 4.7k~10kΩ resistor. Its states are:

Low (0~0.8V):	Transmitter on
(>0.8V, <2.0V):	Undefined
High (2.0~3.465V):	Transmitter Disabled
Open:	Transmitter Disabled
- MOD-DEF 0,1,2 are the module definition pins. They should be pulled up with a 4.7k~10kΩ resistor on the host board. The pull-up voltage shall be VccT or VccR.
 MOD-DEF 0 is grounded by the module to indicate that the module is present
 MOD-DEF 1 is the clock line of two wires serial interface for serial ID
 MOD-DEF 2 is the data line of two wires serial interface for serial ID
- LOS is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates loss of signal. In the low state, the output will be pulled to less than 0.8V.
- These are the differential receiver output. They are internally AC-coupled 100Ω differential lines which should be terminated with 100Ω (differential) at the user SERDES.

6. These are the differential transmitter inputs. They are AC-coupled, differential lines with 100Ω differential termination inside the module.

EEPROM Information

The SFP MSA defines a 256-byte memory map in EEPROM describing the transceiver's capabilities, standard interfaces, manufacturer, and other information, which is accessible over a 2 wire serial interface at the 8-bit address 1010000X (A0h). The memory contents refer to Table 7.

Table 7 - EEPROM Serial ID Memory Contents (A0h)

Addr.	Field Size (Bytes)	Name of Field	Hex	Description
0	1	Identifier	03	SFP
1	1	Ext. Identifier	04	MOD4
2	1	Connector	07	LC
3—10	8	Transceiver	00 00 00 02 12 00 01 01	Transmitter Code
11	1	Encoding	01	8B10B
12	1	BR, nominal	0D	1.25Gbps
13	1	Reserved	00	
14	1	Length (9um)-km	14	20km
15	1	Length (9um)	C8	20km
16	1	Length (50um)	00	
17	1	Length (62.5um)	00	
18	1	Length (copper)	00	
19	1	Reserved	00	
20—35	16	Vendor name	53 4F 55 52 43 45 50 48 4F 54 4F 4E 49 43 53 20	"SOURCEPHOTONICS"(ASC II)
36	1	Reserved	00	
37—39	3	Vendor OUI	00 1F 22	
40—55	16	Vendor PN	53 50 47 42 45 4C 58 43 44 46 4D 20 20 20 20 20	"SPGBELXCDFM" (ASC II)
56—59	4	Vendor rev	xx xx xx xx	ASC II ("31 30 20 20" means 1.0 revision)
60-61	2	Wavelength	05 1E	1310nm
62	1	Reserved	00	
63	1	CC BASE	xx	Check sum of bytes 0 - 62
64—65	2	Options	00 1A	LOS, TX_FAULT and TX_DISABLE
66	1	BR, max	00	
67	1	BR, min	00	
68—83	16	Vendor SN	xx xx xx xx xx xx xx xx xx xx xx xx xx xx xx xx	ASC II .

84—91	8	Vendor date code	xx xx xx xx xx xx 20 20	Year (2 bytes), Month (2 bytes), Day (2 bytes)
92	1	Diagnostic type	68	Diagnostics(Int.Cal)
93	1	Enhanced option	B0	Diagnostics(Optional Alarm/warning flags, Soft TX_FAULT and Soft TX_LOS monitoring)
94	1	SFF-8472	02	Diagnostics(SFF-8472 Rev 9.4)
95	1	CC_EXT	xx	Check sum of bytes 64 - 94
96—255	160	Vendor specific		

Note: The “xx” byte should be filled in according to practical case. For more information, please refer to the related document of SFF-8472 Rev 9.5.

Monitoring Specification

The digital diagnostic monitoring interface also defines another 256-byte memory map in EEPROM, which makes use of the 8 bit address 1010001X (A2h). Please see Figure 4. For detail EEPROM information, please refer to the related document of SFF-8472 Rev 9.5. The monitoring specification of this product is described in Table 8.

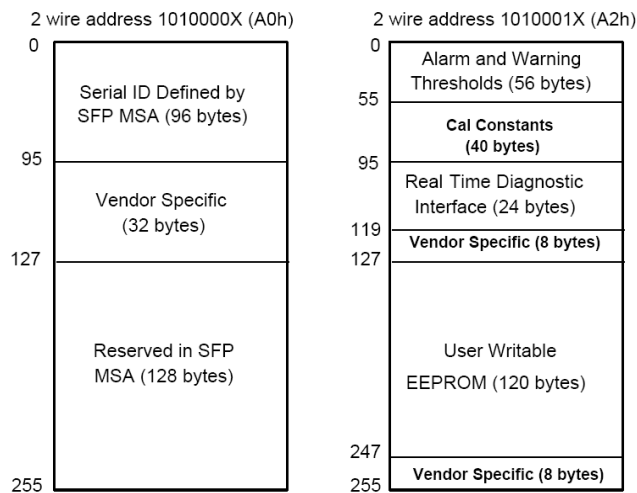
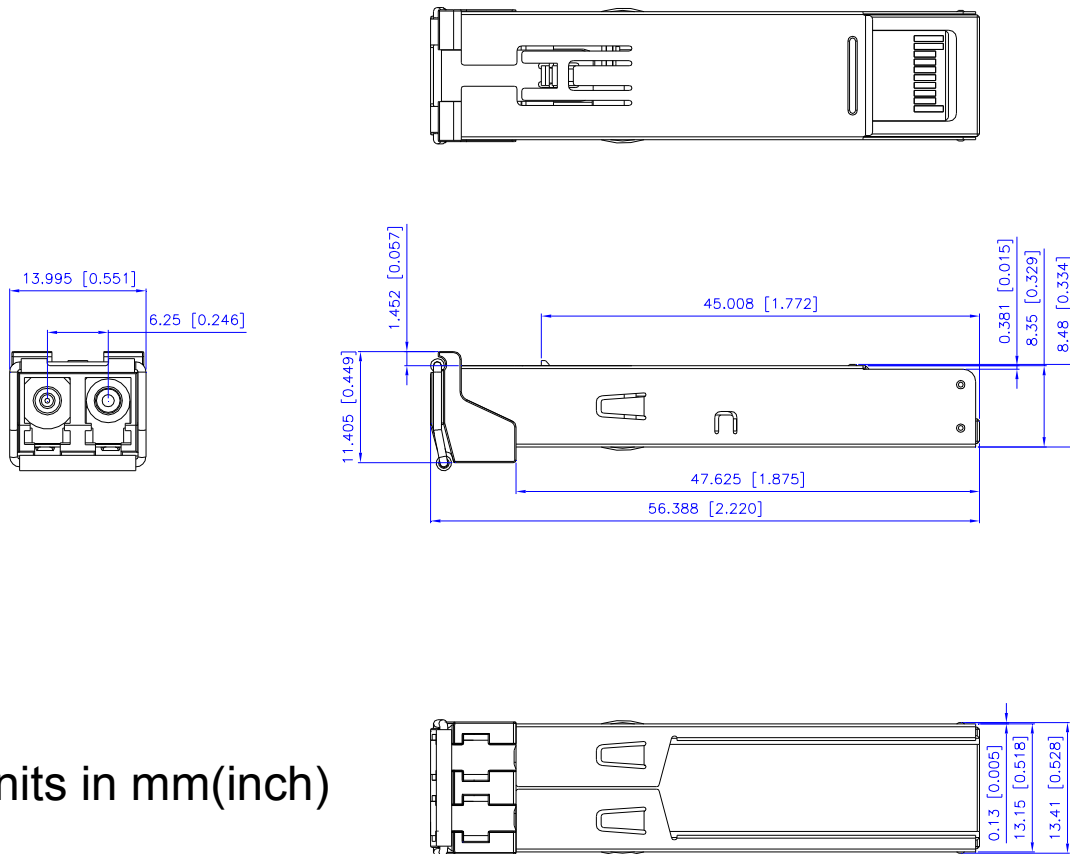


Figure 4, EEPROM Memory Map Specific Data Field Descriptions

Table 8- Monitoring Specification

Parameter	Range	Accuracy	Calibration
Temperature	-10 to 80°C	±3°C	Internal
Voltage	3.0 to 3.6V	±3%	Internal
Bias Current	0 to 100mA	±10%	Internal
TX Power	-8 to -2 dBm	±3dB	Internal
RX Power	-23 to -2 dBm	±3dB	Internal

Mechanical Diagram



Units in mm(inch)

Figure 5, Mechanical Design Diagram of the SFP

Order Information

Table 9 – Order Information

Part No.	Application	Data Rate	Laser Source	Fiber Type
SP-GB-ELX-CDFM	GbE 20Km	1.25Gbps	1310nm FP	SMF

Warnings

Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.

Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

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Contact

U.S.A. Headquarters

20550 Nordhoff Street
Chatsworth, CA 91311
USA
Tel: +1-818-773-9044
Fax: +1-818-773-0261

China

Building #2&5, West Export Processing Zone
No. 8 Kexin Road, Hi-Tech Zone
Chengdu, 611731, China
Tel: +86-28-8795-8788
Fax: +86-28-8795-8789

Taiwan

9F, No 81, Shui Lee Rd.
Hsinchu, Taiwan, R.O.C.
Tel: +886-3-5169222
Fax: +886-3-5169213

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